

PTO/SB/08a (08/03)

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**INFORMATION DISCLOSURE
STATEMENT BY APPLICANT**

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Complete if Known

Application Number	10/046,416
Filing Date	10/19/2001
First Named Inventor	Arthur R. Telkamp
Art Unit	2882
Examiner Name	Sung H. Pak
Attorney Docket Number	703427.6

Sheet 1 of 2

U.S. PATENT DOCUMENTS

Examiner Initials	Cite No. ¹	U.S. Patent Document	Publication Date MM/DD/YYYY	Name of Patentee or Applicant of Cited Document
		Number/Kind Code ² (if known)		
SP	1	5,039,191	07/1991	Myszka
SP	2	5,278,692	01/1994	Delapierre
SP	3	5,357,590	10/1994	Auracher
SP	4	5,596,662	01/1997	Boscher
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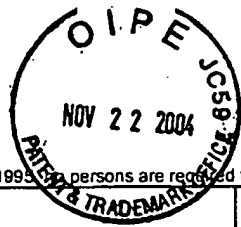
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Examiner Initials	Cite No. ¹	Foreign Patent Document	Publication Date MM/YYYY	Name of Patentee or Applicant of Cited Document	T ⁶
		Country ³ Number ⁴ Kind Code ⁵ (if known)			
SP	19	DE 3817035 C1	08/1989	Messerschmitt/Bölkow/Blom GmbH	
SP	20	EP 0 545 584	11/1992	American Teleph & Telegr	
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SP	27	WO 01/77742 A2	10/2001	Lightwave Microsystems Corp.	

Examiner Signature	Sung Pak	Date Considered	1/21/05
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Sheet 2 of 2

OTHER PRIOR ART / NON PATENT LITERATURE DOCUMENTS

Examiner Initials ¹	Cite No. ¹	Include name of the author (in CAPITAL LETTERS), title of the article (when appropriate), title of the item (book, magazine, journal, serial, symposium, catalog, etc.), date, page(s), volume/issue number(s), publisher, city and/or country where published.	T ²
SP	28	Bahadori, et al., <i>Automated Fiber-Waveguide Array Alignment</i> , Journal of Optical Communications, Fachverlag Schiele & Schon, Berlin, Germany, Vol. 10, no. 2, June 1, 1989, pages 54-55	

DOCSOC1:157250.1

Examiner Signature	Sung Pak	Date Considered	1/21/05
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FORM PTO-1449 LIST OF PATENTS AND OTHER ITEMS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT (Use several sheets if necessary)	<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 50%;"> ATTY. DOCKET NO. 268/001 </td> <td style="width: 50%;"> SERIAL NO. 10/046,416 </td> </tr> <tr> <td colspan="2"> APPLICANT: Telkamp, et al. </td> </tr> <tr> <td> FILING DATE: October 19, 2001 </td> <td> GROUP: N/A </td> </tr> </table>	ATTY. DOCKET NO. 268/001	SERIAL NO. 10/046,416	APPLICANT: Telkamp, et al.		FILING DATE: October 19, 2001	GROUP: N/A
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FILING DATE: October 19, 2001	GROUP: N/A						

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	Telkamp, et al.	
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